EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	19899847	past$3 bond$3 join$3 bind$3 connect$3 link $3 glu$3 unit$3 adher $3 align$3 alignment mount$3 laminat$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/11 07:53
S2	2900368	wafer package semiconductor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/11 07:54
S3	1442575	(carrier rear support stick$3 thin planar) adj (film plate base support substrate member)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/11 07:55
S4	35084	(pour$3 heat$3 spread$3) near10 wax	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/11 07:55
S5	2900368	wafer package semiconductor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/11 07:57
S6	1442575	(carrier rear support stick$3 thin planar) adj (film plate base support substrate member)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/11 07:57
S7	142117	S5 with S6	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/11 07:57

S8	121747	S5 near10 S6	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/11 07:58
S9	35084	(pour$3 heat$3 spread$3) near10 wax	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/11 07:59
S10	41	S8 same S9	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/11 07:59
S11	2	S8 same (S9 with thick$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/11 08:11
S12	12	S8 same (S9 same thick$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/11 08:13
S13	4	((S8 same (S9 same thick$4)) same cool $3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/11 08:13
S14	2007	S9 same adjust$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/11 09:01
S15	345	(S9 same adjust$4) same thick$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/11 09:02

S16	2	S15 and S8	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/11 09:02
S17	4	((S9 same adjust$4) same thick$4) same wafer	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/11 09:03
S18	2	((S9 same adjust$4) same thick$4) and S8	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/11 09:05
S19	5	"6309505"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/11 10:50

12/29/2008 4:55:46 PM
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